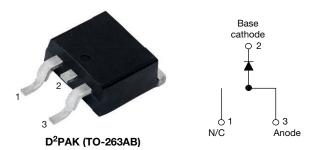
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SHA

High Performance Schottky Rectifier, 19 A



PRIMARY CHARACTERISTICS								
I _{F(AV)}	19 A							
V _R	15 V							
V _F at I _F	0.36 V							
I _{RM} max.	522 mA at 100 °C							
T _J max.	125 °C							
E _{AS}	6.75 mJ							
Package	D ² PAK (TO-263AB)							
Circuit configuration	Single							

FEATURES

- 125 °C T_{.1} operation ($V_B < 5 V$)
- · Optimized for OR-ing applications
- · Ultralow forward voltage drop
- High frequency operation
- · Guard ring for enhanced ruggedness and long term reliability
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC[®]-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The VS-19TQ015S-M3 Schottky rectifier has been optimized for ultralow forward voltage drop specifically for the OR-ing of parallel power supplies. The proprietary barrier technology allows for reliable operation up to 125 °C junction temperature. Typical applications are in parallel switching power supplies, converters, reverse battery protection, and redundant power subsystems.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL CHARACTERISTICS VALUES UNITS									
I _{F(AV)}	Rectangular waveform	19	A						
V _{RRM}		15	V						
I _{FSM}	t _p = 5 μs sine	700	A						
V _F	19 A _{pk} , T _J = 75 °C	0.32	V						
TJ	Range	-55 to +125	C°						

VOLTAGE RATINGS								
PARAMETER SYMBOL VS-19TQ015S-M3 UNITS								
Maximum DC reverse voltage	V _R	15	V					
Maximum working peak reverse voltage	V _{RWM}	15	v					

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDI	TEST CONDITIONS					
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at $T_C = 80$ °C,	19	А				
Maximum peak one cycle non-repetitive surge current			700	А				
See fig. 7	IFSM	10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	330	A			
Non-repetitive avalanche energy	E _{AS}	T _J = 25 °C, I _{AS} = 1.50 A, L = 6 n	6.75	mJ				
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero Frequency limited by T _J maximu	1.50	А				



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ELECTRICAL SPECIFICATI	ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS						
Maximum forward voltage drop See fig. 1		19 A	T.I = 25 °C	0.36	v				
	V _{FM} ⁽¹⁾	38 A	1j=25 C	0.46					
	VFM	19 A	T _{.1} = 75 °C	0.32					
		38 A	1 _J = 75 C	0.43	l				
	I _{RM} ⁽¹⁾	$T_{J} = 100 \text{ °C}, V_{R} = 12 \text{ V}$	465						
Maximum reverse leakage current		$T_{J} = 100 \text{ °C}, V_{R} = 5 \text{ V}$	285						
See fig. 2		T _J = 25 °C	$V_{\rm B}$ = Rated $V_{\rm B}$	10.5	mA				
		T _J = 100 °C	V _R = naleu V _R	522					
Maximum junction capacitance	CT	C_T $V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		2000	pF				
Typical series inductance	L _S	Measured lead to lead 5 n	8.0	nH					
Maximum voltage rate of change	dV/dt	Rated V _R	10 000	V/µs					

Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction temperature range		TJ		-55 to +125	°C		
Maximum storage temperature range		T _{Stg}		-55 to +150	-0		
Maximum thermal resistance, junction to case		R _{thJC}	DC operation See fig. 4	1.50	°C/W		
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth, and greased	0.50	0/10		
Approximate weight				2	g		
Approximate weight				0.07	oz.		
Mounting torque	minimum			6 (5)	kgf · cm		
Mounting torque	maximum			12 (10)	(lbf · in)		
Marking device			Case style D ² PAK (TO-263AB)	19TQ	015S		

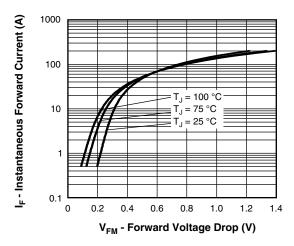


Fig. 1 - Maximum Forward Voltage Drop Characteristics

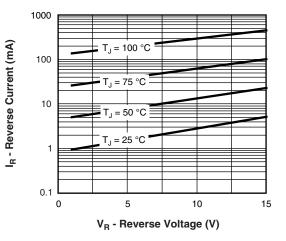


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

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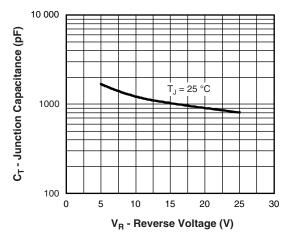
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Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

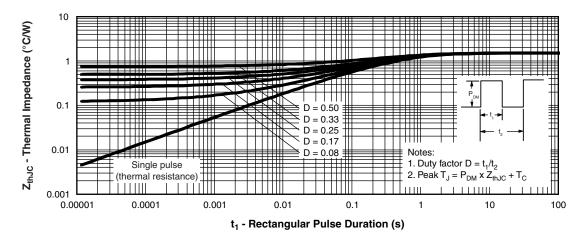
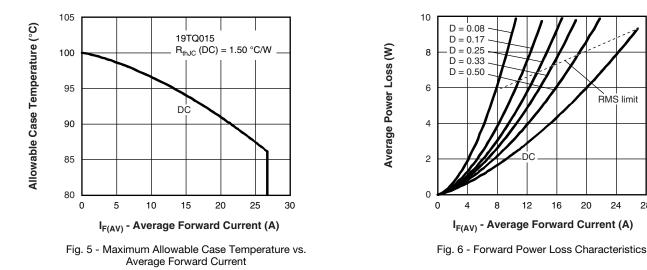


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



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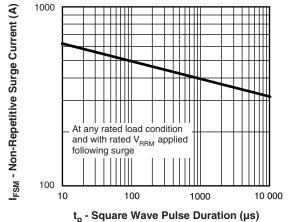


Fig. 7 - Maximum Non-Repetitive Surge Current

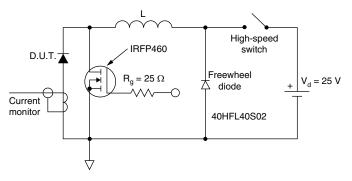


Fig. 8 - Unclamped Inductive Test Circuit

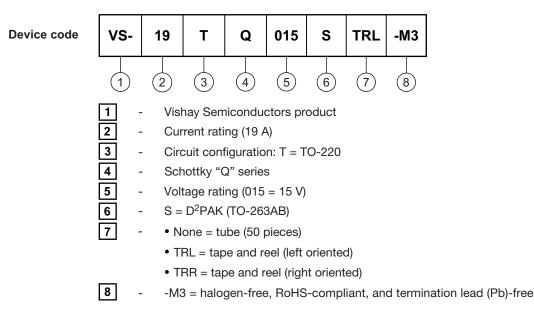


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ORDERING INFORMATION TABLE

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ORDERING INFORMATION (Example)								
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION						
VS-19TQ015S-M3	50	Antistatic plastic tubes						
VS-19TQ015STRL-M3	800	13" diameter plastic tape and reel						
VS-19TQ015STRR-M3	800	13" diameter plastic tape and reel						

	LINKS TO RELATED DOCUMENTS
Dimensions	www.vishay.com/doc?96164
Part marking information	www.vishay.com/doc?95444
Packaging information	www.vishay.com/doc?96424
SPICE model	www.vishay.com/doc?96005

Outline Dimensions



D²PAK

DIMENSIONS in millimeters and inches

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SYMBOL	MILLIMETERS		INCHES		NOTES	S NOTES		SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWDUL	MIN.	MAX.	MIN.	MAX.	NOTES	
A	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3	
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420	2, 3	
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3	
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC		
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625		
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110		
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3	
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070		
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC		
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208		

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5 M-1994

⁽²⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

⁽³⁾ Thermal pad contour optional within dimension E, L1, D1 and E1

⁽⁴⁾ Dimension b1 and c1 apply to base metal only

⁽⁵⁾ Datum A and B to be determined at datum plane H

⁽⁶⁾ Controlling dimension: inch

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-263AB

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